

U.S. Patent Application Serial No. 10/615,381  
Amendment filed April 9, 2007  
Reply to OA dated January 8, 2007

**AMENDMENTS TO THE CLAIMS:**

This listing of claims will replace all prior versions, and listings, of claims in the application:

**Listing of Claims:**

**Claims 1-13 (Canceled).**

**Claim 14 (Previously Presented):** A surface treating apparatus according to claim 21, wherein said vapor deposition controlling gas is hydrogen.

**Claim 15 (Previously Presented):** A surface treating apparatus according to claim 21, wherein the molar ratio of said vapor deposition controlling gas to oxygen in at least a space between said melting/evaporating source and said work within said treating chamber can be adjusted by the feed rate of said vapor-depositing material fed from said feed reel.

**Claims 16 - 20 (Canceled).**

**21. (Currently Amended):** A surface treating apparatus comprising:  
a treating chamber connected to an evacuating system;  
a melting/evaporating source for melting and evaporating a wire-shaped vapor-depositing

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material containing a vapor deposition controlling gas, disposed in the treating chamber;  
a rotatable cage-shaped, work retaining member, disposed in the treating chamber, and spaced above the melting/evaporating source, for retaining a work on which the vapor depositing material is deposited;  
a supply of wire-shaped vapor-depositing material containing a predetermined amount of the vapor deposition controlling gas wound about a feed reel;  
a thermal resistant protective tube disposed between the feed reel and the melting/evaporating source; and  
the feed reel being mounted so as to rotate about a substantially substantially vertical rotational axis, and disposed in the treating chamber below the melting/evaporating source; such that, as the wire-shaped vapor-depositing material containing the vapor deposition controlling gas is supplied from the feed reel to the melting/evaporating source, the wire-shaped vapor-depositing material containing the vapor deposition controlling gas has a horizontally disposed lower portion, a vertically disposed intermediate portion and a horizontally disposed upper portion, and the wire-shaped vapor-depositing material containing the vapor deposition controlling gas is protected by the thermal resistant protective tube between the feed reel and the melting/evaporating source.